

Title (en)

LAYERED STACKS AND METHODS OF PRODUCTION THEREOF

Title (de)

GESCHICHTETE STAPEL UND VERFAHREN ZU IHRER HERSTELLUNG

Title (fr)

EMPILEMENTS STRATIFIES ET PROCEDES DE PRODUCTION CORRESPONDANTS

Publication

EP 1379340 A1 20040114 (EN)

Application

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Priority

- US 0211927 W 20020416
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Abstract (en)

[origin: WO02083327A1] Low dielectric constant layered materials and a method for making said layered materials comprising the steps of: a) providing a surface; b) spinning a dielectric material on to the surface; c) curing the dielectric material to form a dielectric layer; d) spinning a low dielectric constant material on to the dielectric layer; and e) curing the low dielectric constant material to form a low dielectric constant layer. Each layer can be spun-on to the layered component and subsequently cured before additional layers are added or all layers can be spun-on to the layered component and then the entire stack is cured at once.

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B05D 7/00; B32B 9/04; H01L 21/00

IPC 8 full level

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CPC (source: EP KR)

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